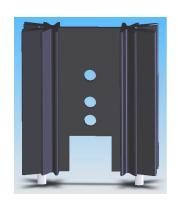
# T0-202 & T0-220

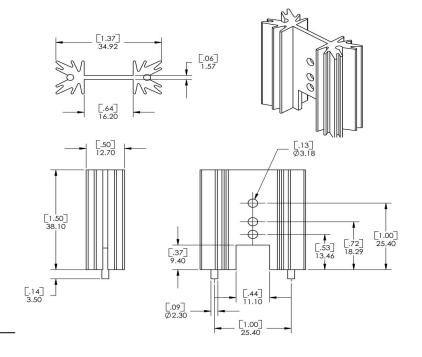
## **Board Level Heat Sinks**



**ThermaFlo** 

### P/N: 411915B02500





#### **PRODUCT SPECIFICATIONS**

Devices: TO-202 & TO-220Size: 12.7 x 34.9 x 38.1 mm

Material: AluminumWeight: 15.7 gramsType: Extruded

• PCB Mounting: Solderable Pins

· Finish: Black Anodized

• Package: Bulk

 Accessories: Hardware & Thermal Interface Material

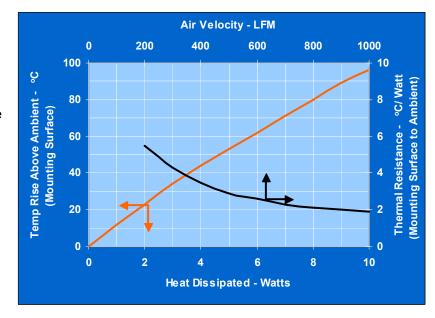
#### FEATURES & BENEFITS -

- Multiple Holes for Device Attachment
- · Dual Device Cooling Heat Sink
- Vertical Mounting via Solderable Pins
- RoHS Compliant



#### **CUSTOMIZED HEATSINKS**

- · Specialized Plating
- · Specialized Body Configurations
- · Contact Applications Engineering



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